

## APTF1616SEEZGOBDC

1.6 x 1.6 mm Full-Color Surface Mount LED



### DESCRIPTIONS

- The Hyper Red source color devices are made with AIGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

### **FEATURES**

- 1.6 mm x 1.6 mm SMD LED, 0.7 mm thickness
- Low power consumption
- · Can produce any color in visible spectrum, including white light
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

### **APPLICATIONS**

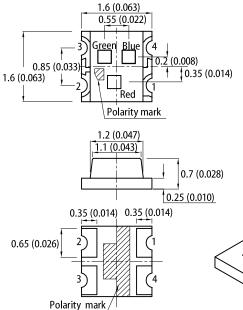
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

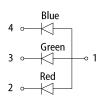
### **ATTENTION**

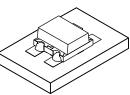
Observe precautions for handling electrostatic discharge sensitive devices



### PACKAGE DIMENSIONS

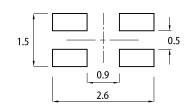






### **RECOMMENDED SOLDERING PATTERN**

(units : mm; tolerance :  $\pm 0.1$ )



#### Notes.

- All dimensions are in millimeters (inches). Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to

change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

### **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>
			Min.	Тур.	201/2
	■ Hyper Red (AlGaInP)	Water Clear	55	110	
APTF1616SEEZGQBDC	Green (InGaN)		120	280	130°
	Blue (InGaN)		40	70	

Notes

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.

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### ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Querra ha h	Funitting Only	Value		11	
Parameter	Symbol	Emitting Color	Тур.	Max.	Max. Unit	
Wavelength at Peak Emission $I_F$ = 20mA	$\lambda_{peak}$	Hyper Red Green Blue	630 515 460	-	nm	
Dominant Wavelength I <sub>F</sub> = 20mA	$\lambda_{dom}$ <sup>[1]</sup>	Hyper Red Green Blue	621 525 465	-	nm	
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 20mA	Δλ	Hyper Red Green Blue	20 35 25	-	nm	
Capacitance	С	Hyper Red Green Blue	25 45 100	-	pF	
Forward Voltage I <sub>F</sub> = 20mA	V <sub>F</sub> <sup>[2]</sup>	Hyper Red Green Blue	2 3.3 3.3	2.5 4.1 4	V	
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Hyper Red Green Blue	-	10 50 50	μΑ	
Temperature Coefficient of $\lambda_{\text{peak}}$ $I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C	$TC_{\lambda peak}$	Hyper Red Green Blue	0.13 0.05 0.04	-	nm/°C	
Temperature Coefficient of $\lambda_{dom}$ $I_F$ = 20mA, -10°C $\leq T \leq 85^\circ C$	$TC_{\lambda dom}$	Hyper Red Green Blue	0.06 0.03 0.03	-	nm/°C	
Temperature Coefficient of $V_F$ $I_F$ = 20mA, -10°C $\leq$ T $\leq$ 85°C	TCv	Hyper Red Green Blue	-2 -3 -3	-	mV/°C	

Notes:

1. The dominant wavelength ( $\lambda d$ ) above is the setup value of the sorting machine. (Tolerance  $\lambda d$ : ±1nm.) 2. Forward voltage: ±0.1V.

Provaria voirage: 50.17.
Wavelength value is traceable to CIE127-2007 standards.
Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

### ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

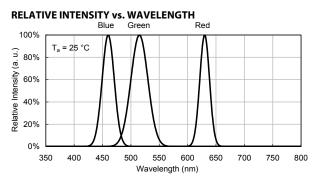
Deveneder	Symbol	Value			
Parameter		Hyper Red	Green	Blue	Unit
Power Dissipation	PD	75	102.5	120	mW
Reverse Voltage	V <sub>R</sub>	5	5	5	V
Junction Temperature	Tj	115	115	115	°C
Operating Temperature	T <sub>op</sub>	-40 to +85			°C
Storage Temperature	T <sub>stg</sub>	-40 to +85			°C
DC Forward Current	IF	30	25	30	mA
Peak Forward Current	<sub>FM</sub> <sup>[1]</sup>	195	150	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	250	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	560	690	495	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	455	590	385	°C/W

Notes: 1. 1/10 Duty Cycle , 0.1ms Pulse Width . 2. R<sub>In JA</sub> , R<sub>In JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

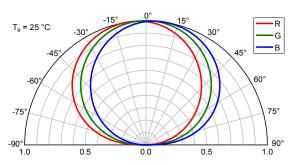
## **Kingbright**

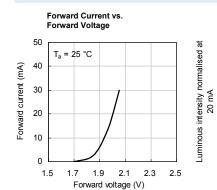
### APTF1616SEEZGOBDC

### **TECHNICAL DATA**



### SPATIAL DISTRIBUTION





Forward Current vs.

Forward Voltage

T<sub>a</sub> = 25 °C

50

40

20

10

0

2.0 2.5

Forward current (mA) 30

## Luminous Intensity vs. Forward Current T<sub>a</sub> = 25 °C

2.5

2.0

1.5

1.0

0.5

0.0

2.5

2.0

1.0

0.5

0.0

2.5

2.0

0.5

0.0

0 10 20 30 40 50

at 20 mA

0

Luminous intensity normalised at

20 mA 1.5 0

10 20 30 40

Forward current (mA)

Luminous Intensity vs.

20 30

Luminous Intensity vs.

Forward Current

T<sub>a</sub> = 25 °C

Forward current (mA)

Forward current (mA)

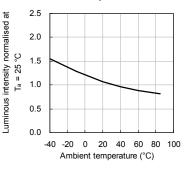
Forward Current

T<sub>a</sub> = 25 °C

10

Forward Current Derating Curve 50 Permissible forward current (mA) 40 30 20 10 0 0 20 40 60 80 100 -40 -20 Ambient temperature (°C)

Luminous Intensity vs. Ambient Temperature



GREEN

50

40

30

20

10

0

-40

-20 0

Permissible forward current (mA)

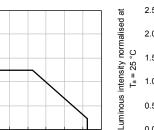
50

BLUE

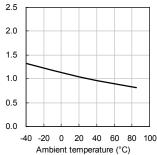
50

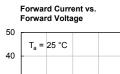
**HYPER RED** 





Luminous Intensity vs. Ambient Temperature





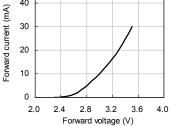
3.0

Forward voltage (V)

4.0

4.5

3.5



40

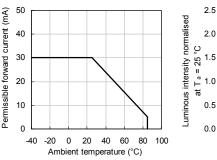


Forward Current Derating Curve

20 40 60 80 100

> Luminous Intensity vs. Ambient Temperature

> > 2.5



0.0

-20 0 20 40 60 80 100 -40 Ambient temperature (°C)



Luminous intensity normalised

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### APTF1616SEEZGOBDC

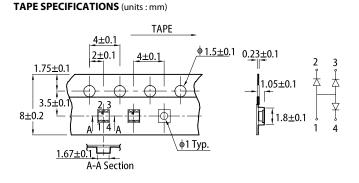
#### **REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS**

#### 300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~150s 60~120s 50 -25°C 0 0 50 100 150 200 250 300 (sec) Time -

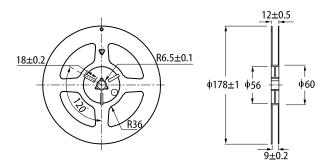
Notes

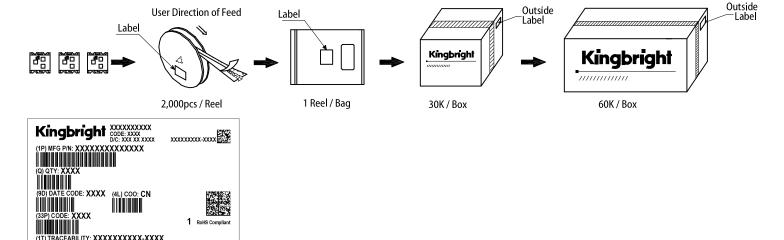
 Don't cause stress to the LEDs while it is exposed to high temperature.
The maximum number of reflow soldering passes is 2 times.
Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product

### **PACKING & LABEL SPECIFICATIONS**



**REEL DIMENSION** (units : mm)





#### **PRECAUTIONARY NOTES**

(SP)XXXXXXXXXXX

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to 2. the latest datasheet for the updated specifications. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
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<sup>6.</sup> All design applications should refer to Kingbright application notes available at https://www.King rightUSA co ationNotes